

APPROVAL SHEET

Shenzhen Bereal Technology.,Ltd
Room 736, Area A, Building C, Qinghu Science Park, Longhua
District, Shenzhen, China

CrossAir™ SMD antenna series RoHS Compliance

Model: CA-C01

2.4 GHz ISM band antenna

Approval sheet

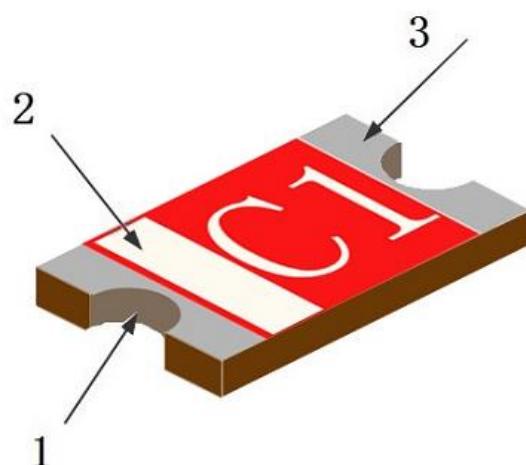
FEATURES

1. Surface Mounted Devices with a small dimension of $3.2 \times 1.6 \times 0.4 \text{ mm}^3$ meet miniaturization trend.
2. Low power loss and high antenna efficiency.
3. High stability in Temperature and Humidity Change.

APPLICATIONS

1. 2.4GHz ISM band RF applications
2. Bluetooth, Wireless, HomeRF

CONSTRUCTION



1、Antenna Feeding

2、Identification Mark

3、Soldering terminal

DIMENSIONS

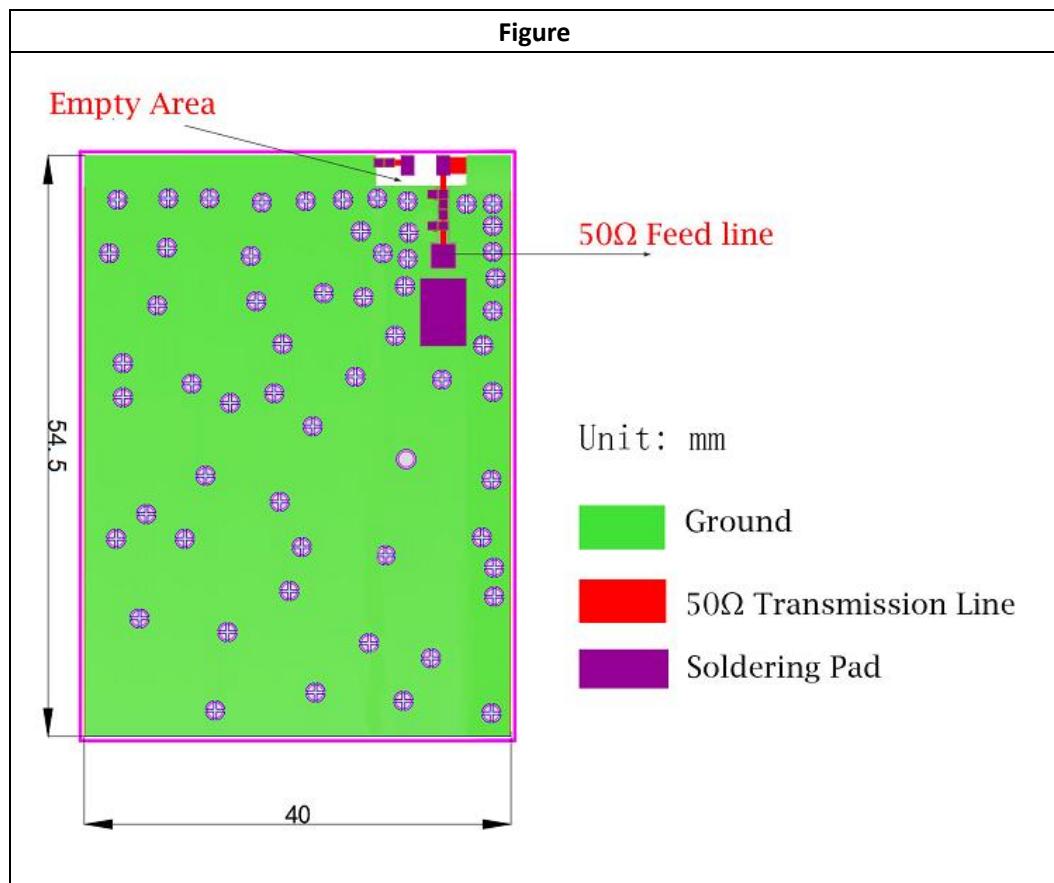
Figure	Symbol	Dimension(mm)
<p>a=0.6 (mm) W= 1.6 (mm) L= 3.2 (mm) T= 0.4 (mm)</p>	L	3.2±0.1
	W	1.6±0.1
	T	0.4±0.05
	a	0.6±0.1

ELECTRICAL CHARACTERISTICS

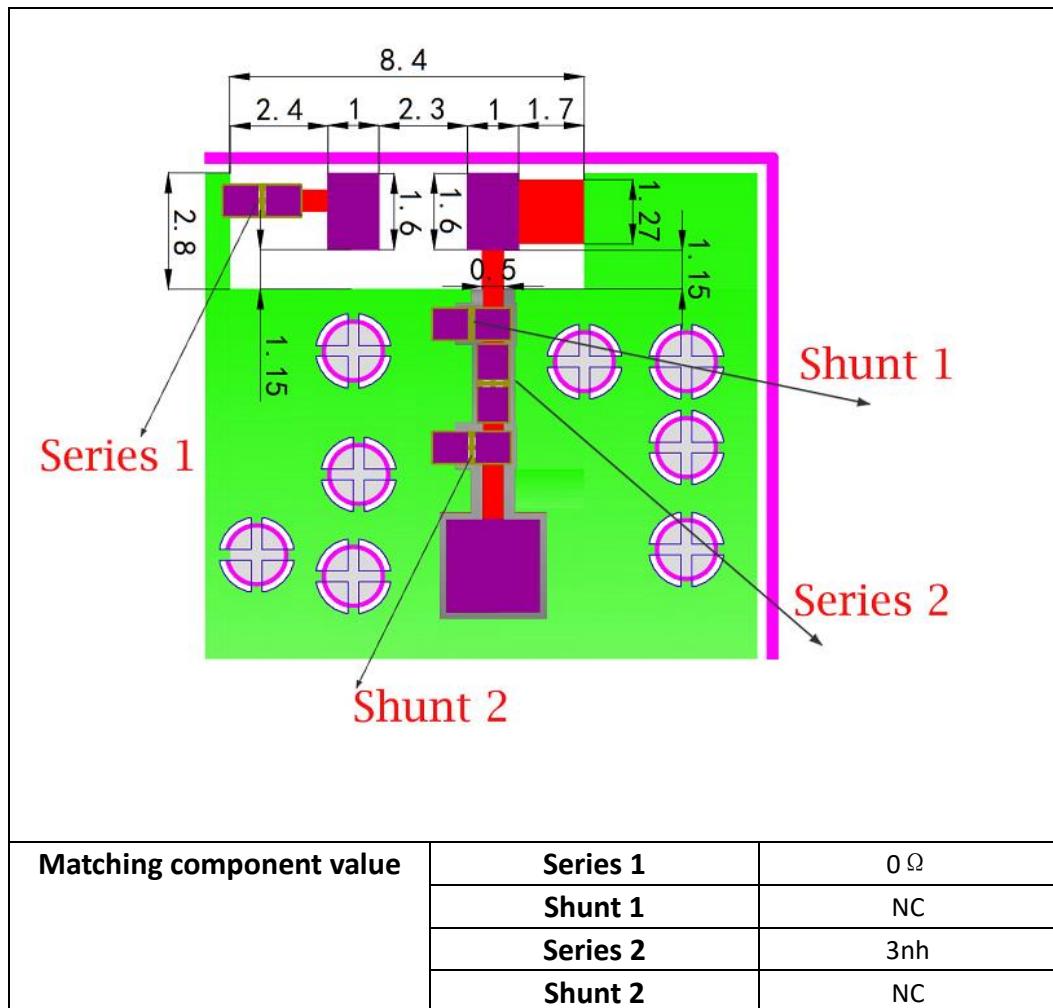
CA-C01	Specification
Working Frequency Range	$2450 \pm 50\text{MHz}$
Band Width	$>100\text{MHz}$
Impedance	50Ω
Gain(dBi)	0.2
VSWR	<2
Operation Temperature	$-40^\circ\text{C} \sim +85^\circ\text{C}$
Power Capacity	3W

The working frequency need be adjusted to 2.45GHz with matching circuit.

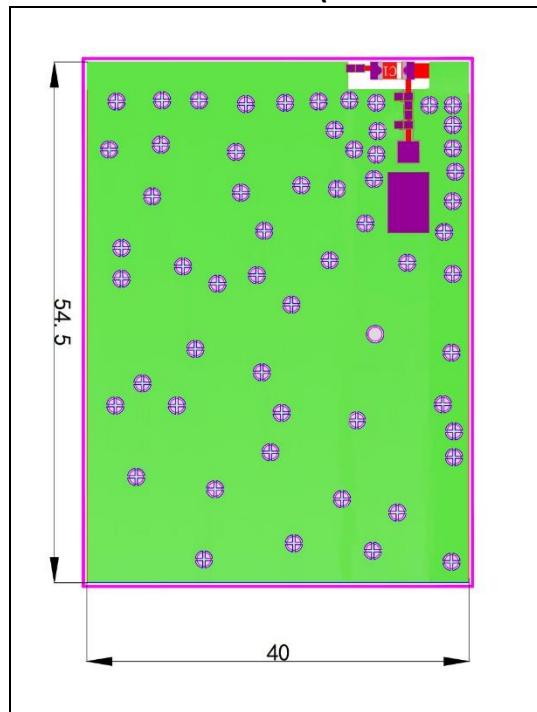
SOLDER LAND PATTERN DESIGN



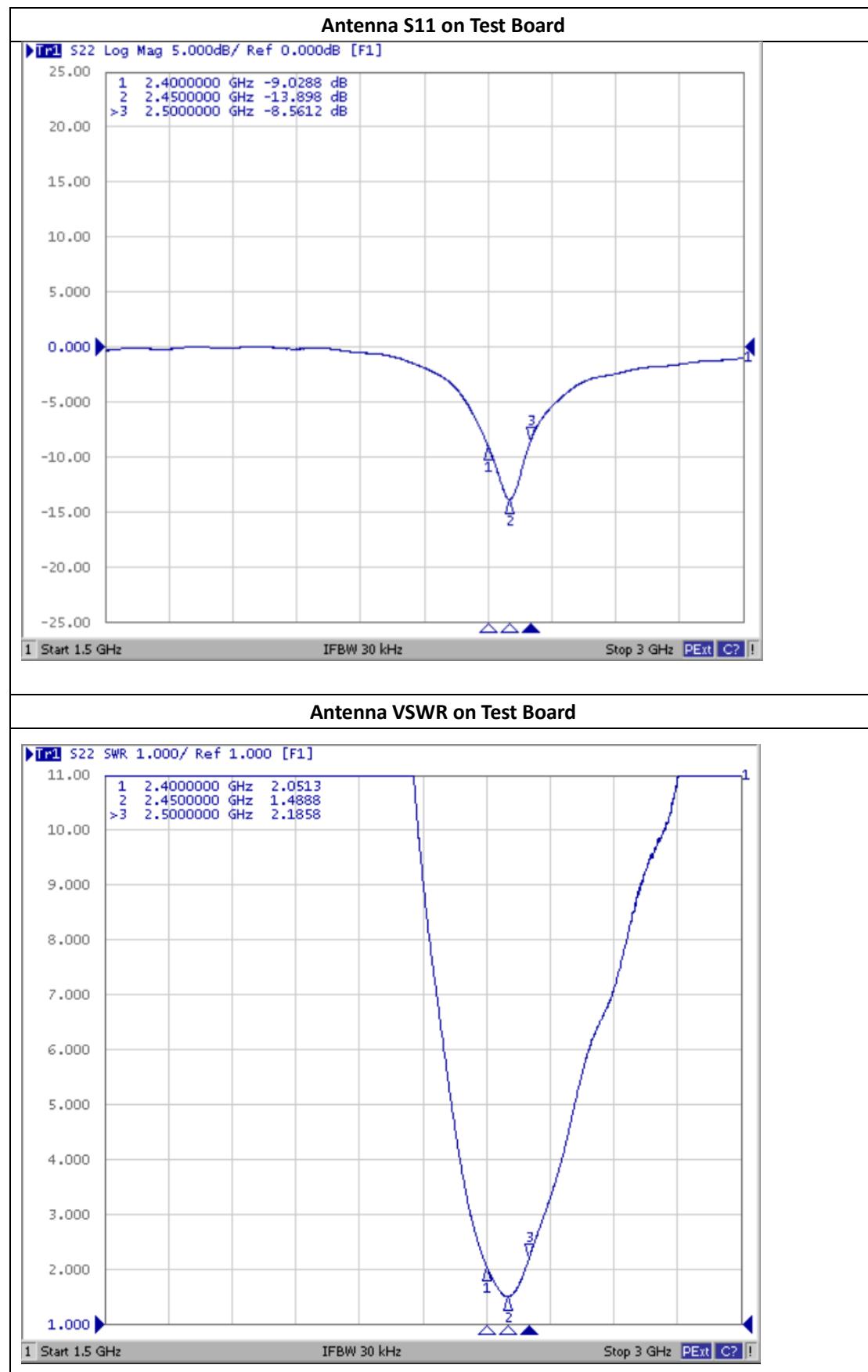
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Antenna on Test Board (Thickness 1.0mm)



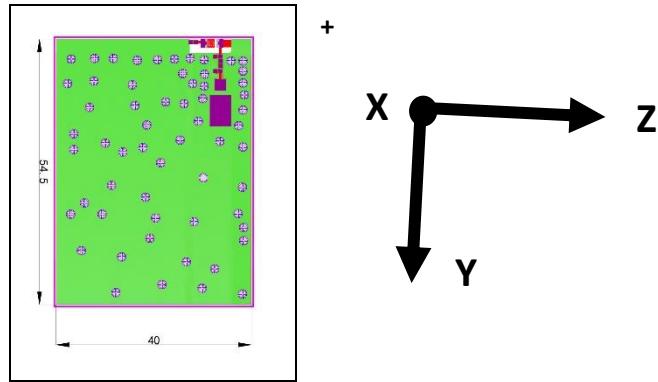
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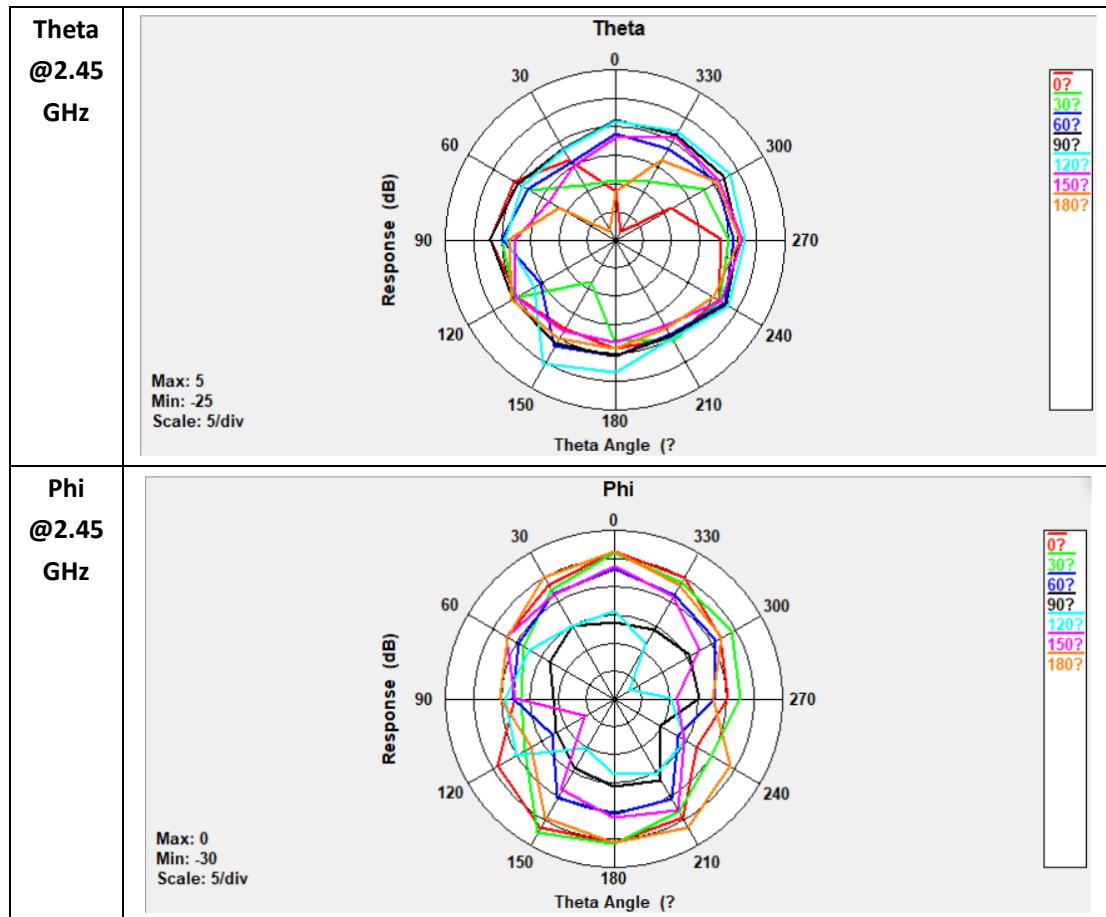
Efficiency and RADIATION PATTERN

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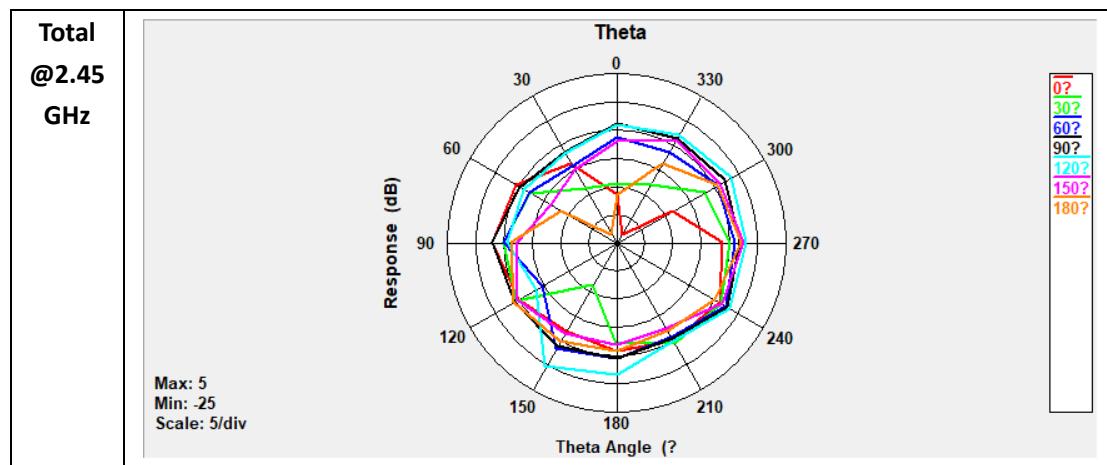
Efficiency, Radiation Pattern and Gain were dependent on measurement board design. The specification of CA-C01 antenna was measured based on the PCB size and installation position as shown in the below figure test board. The test results were tested in ETS 3D Chamber.



Gain and Efficiency		2.4G-2.5GHz
Peak Gain		0.2dBi
Average Gain across the band		0.06dBi
Gain Range across the band		-0.17dBi~0.2dBi
Peak Efficiency		41.3%
Average Efficiency across the band		40.1%
Efficiency Range across the band		37.8%~41.3%

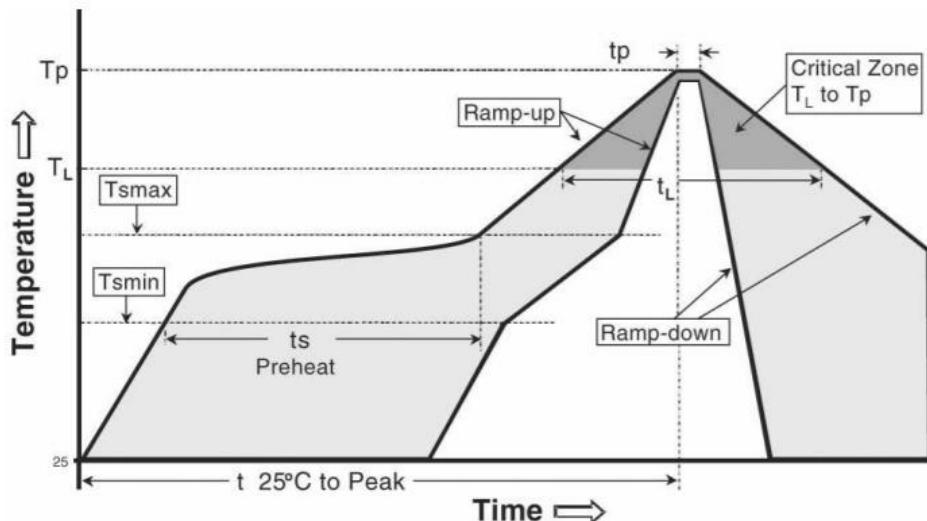


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SOLDERING CONDITION

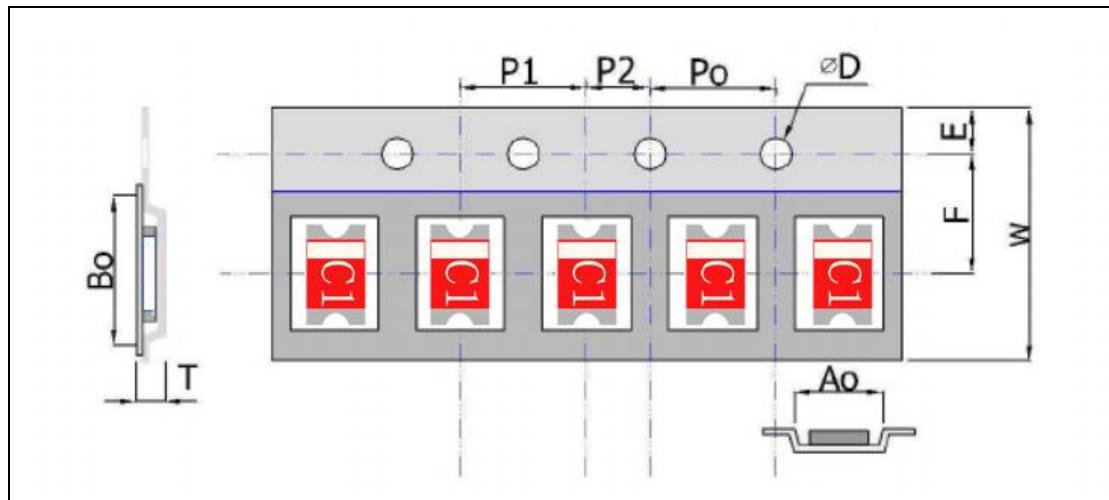
Typical examples of soldering processes that provide reliable joints without any damage is as follows:



Phase	Profile features	Pb-Free assembly (SnAgCu)
RAMP-UP	Avg. Ramp-up Rate (Tsmax to Tp)	3 °C / second (max.)
PREHEAT	<ul style="list-style-type: none"> - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (tsmin to tsmax) 	150 °C 200 °C 60-180 seconds
REFLOW	<ul style="list-style-type: none"> - Temperature (TL) - Total Time above TL (tL) 	217 °C 60-150 seconds
PEAK	<ul style="list-style-type: none"> - Temperature (Tp) - Time (tp) 	260 °C 20-40 seconds
RAMP-DOWN	Rate	6 °C/second max
Time from 25 °C to Peak Temperature		8 minutes max

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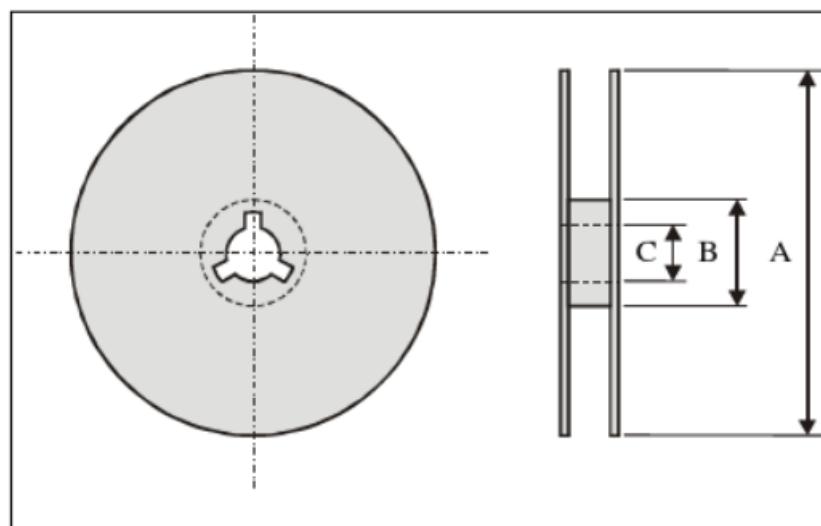
PACKAGING



Plastic Tape specification (unit:mm)

Index	Ao	Bo	ΦD	T	W
Dimension (mm)	2.0 ± 0.1	3.6 ± 0.1	1.55 ± 0.05	0.9 ± 0.1	8.2 ± 0.1
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.1	3.2 ± 0.1	4.0 ± 0.1	4.0 ± 0.1	2.0 ± 0.1

Reel dimensions



Index	A	B	C
Dimension(mm)	178	60	13.5

Typing Quantity: 3000 pieces per reel.

CAUTION OF HANDLING

Storage environment condition

Products should be storage in the warehouse on the following conditions:

Temperature : $-10^{\circ}\text{C} \sim +40^{\circ}\text{C}$

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Humidity : 30% to 70% relative humidity

Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.

Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.

Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.

Products should be storage under the airtight packaged condition.